

#### Description

The KMB3D5N40SA uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

 $V_{DS} = 40V I_D = 5A$   $R_{DS(ON)} < 38m\Omega @ V_{GS} = 10V$  $R_{DS(ON)} < 52m\Omega @ V_{GS} = 4.5V$ 

### Application

Battery protection Load switch Uninterruptible power supply

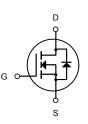
## Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
KMB3D5N40SA	SOT-23	2318	3000

### Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter Rating		Units		
Vds	Drain-Source Voltage	40	V		
Vgs	Gate-Source Voltage	±20			
	Drain Current – Continuous (Tc=25°C)	5	А		
ld	Drain Current – Continuous (Tc=70 $^\circ C$ )	4.2	А		
PD	Power Dissipation (Tc=25°C)	1.56	W		
Tstg	Storage Temperature Range	-55 to 150	°C		
TJ	Operating Junction Temperature Range	-55 to 150 °C			
R <sub>0JA</sub>	Thermal Resistance Junction to ambient	tion to ambient 80 °C/W			





N-Channel MOSFET



# KMB3D5N40SA

N-Channel Enhancement Mode MOSFET

Symbol	Parameter	Condition	Min	Тур	Max	Unit	
Static Elec	Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	Vgs=0V Id=250µA	40			V	
	Zero Gate Voltage Drain Current(T₄=25℃)	VDS=40V, VGS=0V			1	μA	
DSS	Zero Gate Voltage Drain Current(T <sub>A</sub> =125°C)	VDS=40V, VGS=0V			100	uA	
I <sub>GSS</sub>	Gate-Body Leakage Current	Vgs=±20V, Vds=0V			±100	nA	
$V_{\rm GS(TH)}$	Gate Threshold Voltage	Vds=Vgs, Id=250µA	0.7	1.9	2.5	V	
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance②	Vgs=10V, Id=5A		30	38	mΩ	
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance②	Vgs=4.5V, Id=4A		36	52	mΩ	
Dynamic I	Electrical Characteristics @ Tյ = 25°C (ι	unless otherwise state	ed)				
C <sub>iss</sub>	Input Capacitance			340		pF	
C <sub>oss</sub>	Output Capacitance	VDS=20V, VGS=0V, f=1MHz		60		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			30		pF	
R <sub>g</sub>	Gate Resistance	f=1MHz		7.8		Ω	
$Q_{g}$	Total Gate Charge	VDS=20V		5.8		nC	
$Q_{gs}$	Gate Source Charge	ID=5A,		0.4		nC	
$Q_{gd}$	Gate Drain Charge	Vgs=10V		2		nC	
	Characteristics @ TJ = 25°C (unless ot	herwise stated)					
t <sub>d(on)</sub>	Turn on Delay Time			4.1		ns	
t,	Turn on Rise Time	VDD=20V, ID=3.5A, RG=1Ω, VGS=4.5V		11.6		ns	
t <sub>d(off)</sub>	Turn Off Delay Time		-	24		ns	
t <sub>f</sub>	Turn Off Fall Time	V00-7.0V		7.6		ns	
Source Drain Diode Characteristics @ TJ = 25°C (unless otherwise stated)							
I <sub>SD</sub>	Source drain current(Body Diode)	T <sub>A</sub> =25℃			1.75	A	
$V_{SD}$	Forward on voltage②	Tj=25℃, IsD=3.5A, Vgs=0V		0.79	1.2	V	

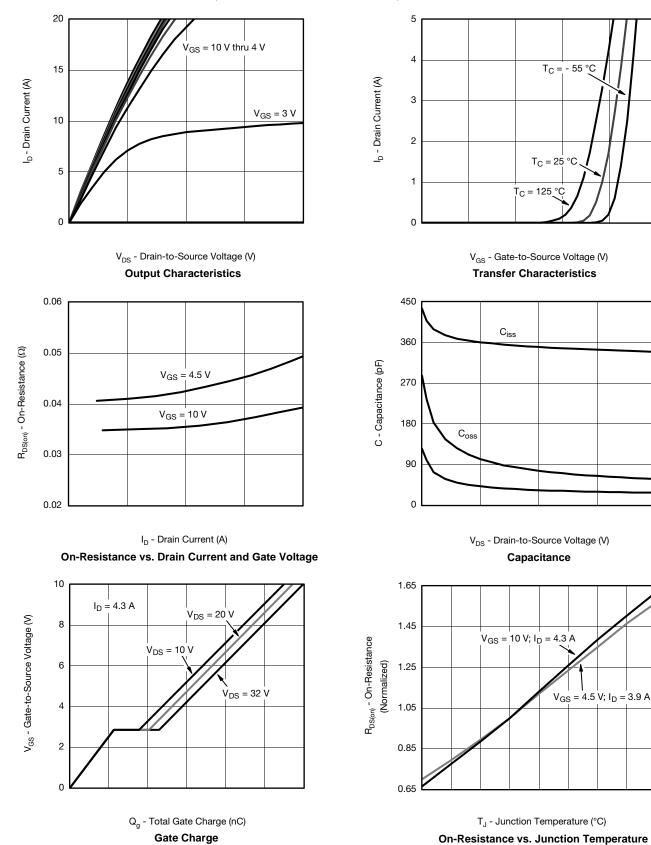
Notes:

1 Pulse width limited by maximum allowable junction temperature

2 Pulse test ; Pulse width ${\leq}300\mu s,$  duty cycle  ${\leq}2\%.$ 



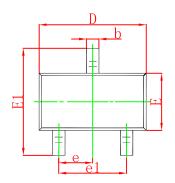
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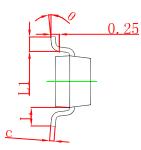


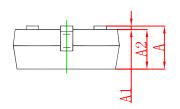
### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



## **SOT-23 Package Outline Dimensions**

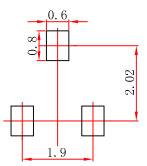






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

## SOT-23 Suggested Pad Layout



Note: 1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.
 3.The pad layout is for reference purposes only.



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